3.2x1.6mm SMD CHIP LED LAMP



ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

APTR3216MBC

BLUE

Features

- •3.2mmx1.6mm SMT LED,1.05mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VAVRIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •RoHS COMPLIANT.

Description

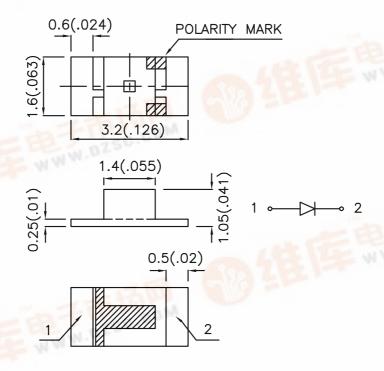
The Blue source color devices are made with GaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	lv (m @ 20	,	Viewing Angle
			Min. Typ.		201/2
APTR3216MBC	BLUE (GaN)	WATER CLEAR	4	10	120°

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	430		nm	IF=20mA
λD	Dominant Wavelength	Blue	466		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	60		nm	IF=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue	3.8	4.5	V	IF=20mA
IR	Reverse Current	Blue		10	uA	VR = 5V

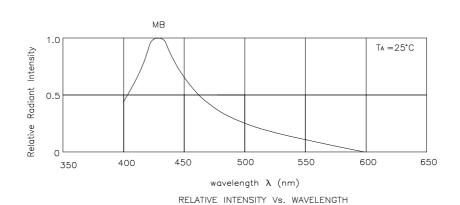
Absolute Maximum Ratings at Ta=25°C

Parameter	Blue	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

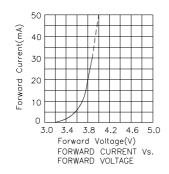
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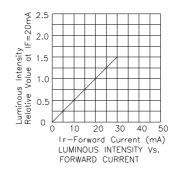
Note: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

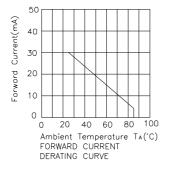
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

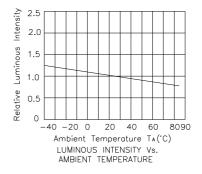


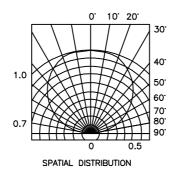
Blue APTR3216MBC







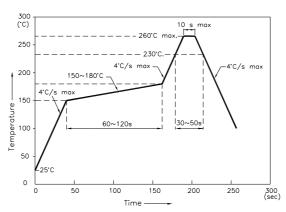




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APTR3216MBC

Reflow Soldering Profile For Lead-free SMT Process.

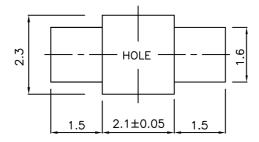


- NOTES:

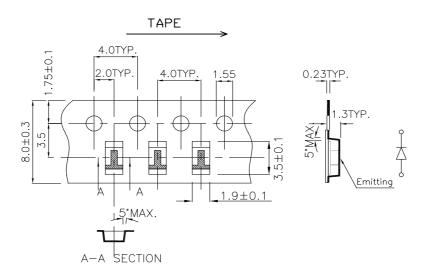
 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern

(Units: mm)



Tape Specifications (Units: mm)



- If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:
- 1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
- 2.Luminous intensity: +/-15% (Test condition is based on the sorting standard).
- 3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).

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